

MOSFET

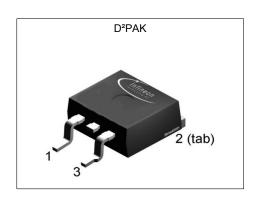
OptiMOS[™]5 Power-Transistor, 150 V

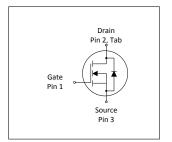
Features

- Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}
 Very low reverse recovery charge (Q_{rr})
 175 °C operating temperature
 Pb-free lead plating; RoHS compliant
 Qualified according to JEDEC¹⁾ for target application
 Ideal for high-frequency switching and synchronous rectification
 Halogen-free according to IEC61249-2-21



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Parameter	Value	Unit					
V _{DS}	150	V					
R _{DS(on),max (TO263)}	7.3	mΩ					
I_{D}	114	A					
Q _{rr}	96	nC					











Type / Ordering Code	Package	Marking	Related Links
IPB073N15N5	PG-TO 263	073N15N5	-

OptiMOS[™]5 Power-Transistor, 150 V IPB073N15N5



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OptiMOS[™]5 Power-Transistor, 150 V . IPB073N15N5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Danamatan	Cymphal		Values			Note / Took Constition	
Parameter	Symbol	Min.	. Тур. Мах.		Unit	Note / Test Condition	
Continuous drain current	I _D	-	-	114 81	А	T _C =25 °C T _C =100 °C	
Pulsed drain current ¹⁾	I _{D,pulse}	-	-	456	Α	<i>T</i> _C =25 °C	
Avalanche energy, single pulse ²⁾	E AS	-	-	130	mJ	$I_{\rm D}$ =100 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	214	W	<i>T</i> _C =25 °C	
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56	

Thermal characteristics 2

Table 3 **Thermal characteristics**

Parameter	Symbol	Values			Unit	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	OIIIL	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	0.4	0.7	K/W	-	
Thermal resistance, junction - ambient, minimal footprint	R _{thJA}	-	-	62	K/W	-	
Thermal resistance, junction - ambient, 6 cm ² cooling area ³⁾	R _{thJA}	-	-	40	K/W	-	

 $^{^{1)}}$ See Diagram 3 $^{2)}$ See Diagram 13 $^{3)}$ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.



3 Electrical characteristics

Table 4 Static characteristics

Downwooden	Values				11		
Parameter	Symbol	Min. Typ.		Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	150	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	V _{GS(th)}	3.0	3.8	4.6	V	V _{DS} =V _{GS} , I _D =160 μA	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =120 V, V _{GS} =0 V, T _j =25 °C V _{DS} =120 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I_{GSS}	-	1	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	5.6 6.1	7.3 7.9	mΩ	V _{GS} =10 V, I _D =57 A V _{GS} =8 V, I _D =29 A	
Gate resistance ¹⁾	R _G	-	1.1	1.7	Ω	-	
Transconductance	g _{fs}	46	91	-	S	$ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 57 A$	

 Table 5
 Dynamic characteristics

Developed	Sumb of	Values					
Parameter	Symbol	Symbol Min.		Max.	Unit	Note / Test Condition	
Input capacitance ¹⁾	Ciss	-	3600	4700	pF	V _{GS} =0 V, V _{DS} =75 V, f=1 MHz	
Output capacitance ¹⁾	Coss	-	900	1200	pF	V _{GS} =0 V, V _{DS} =75 V, f=1 MHz	
Reverse transfer capacitance ¹⁾	C _{rss}	-	21	37	pF	V _{GS} =0 V, V _{DS} =75 V, f=1 MHz	
Turn-on delay time	$t_{ m d(on)}$	-	14	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =57 A, $R_{\rm G,ext}$ =1.6 Ω	
Rise time	t _r	-	4	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =57 A, $R_{\rm G,ext}$ =1.6 Ω	
Turn-off delay time	$t_{ m d(off)}$	-	20	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =57 A, $R_{\rm G,ext}$ =1.6 Ω	
Fall time	t _f	-	4	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =57 A, $R_{\rm G,ext}$ =1.6 Ω	

Table 6 Gate charge characteristics²⁾

Parameter	Cumbal	Values			Linit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	21	-	nC	V_{DD} =75 V, I_{D} =57 A, V_{GS} =0 to 10 V
Gate to drain charge ¹⁾	Q _{gd}	-	10	15	nC	V _{DD} =75 V, I _D =57 A, V _{GS} =0 to 10 V
Switching charge	Q _{sw}	-	17	-	nC	V _{DD} =75 V, I _D =57 A, V _{GS} =0 to 10 V
Gate charge total ¹⁾	Qg	-	49	61	nC	V _{DD} =75 V, I _D =57 A, V _{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	5.7	-	V	V _{DD} =75 V, I _D =57 A, V _{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	136	181	nC	V _{DD} =75 V, V _{GS} =0 V

 $^{^{\}rm 1)}$ Defined by design. Not subject to production test. $^{\rm 2)}$ See "Gate charge waveforms" for parameter definition

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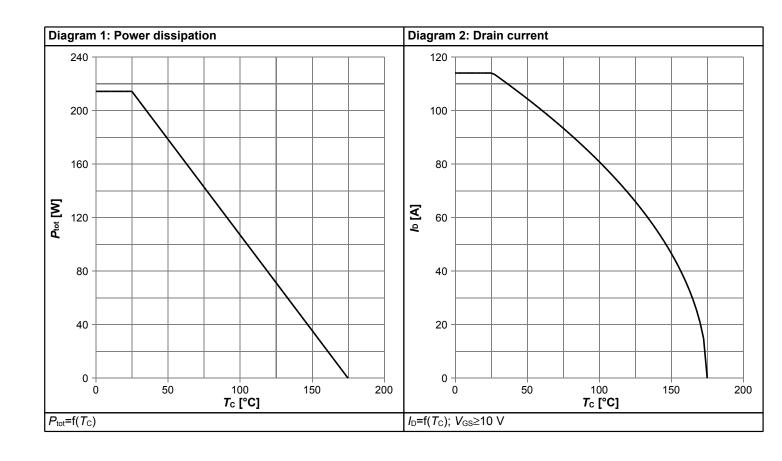


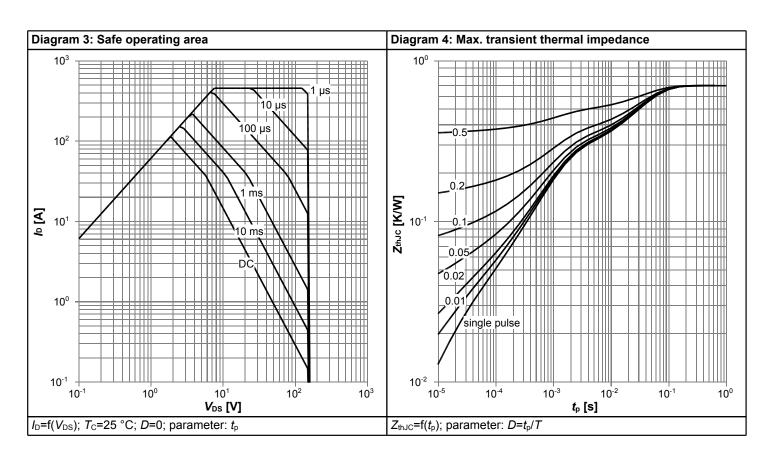
Table 7 Reverse diode

Dovometer	Symbol		Values			Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continous forward current	Is	-	-	114	Α	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	456	Α	<i>T</i> _C =25 °C	
Diode forward voltage	V _{SD}	-	0.87	1.1	V	V _{GS} =0 V, I _F =57 A, T _j =25 °C	
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	69	138	ns	V _R =75 V, I _F =57 A, di _F /dt=100 A/μs	
Reverse recovery charge ¹⁾	Qrr	-	96	192	nC	V_R =75 V, I_F =57 A, di_F/dt =100 A/ μ s	

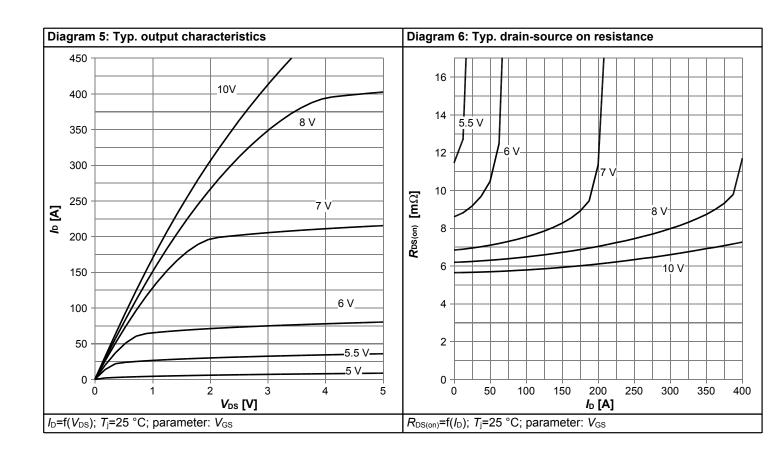


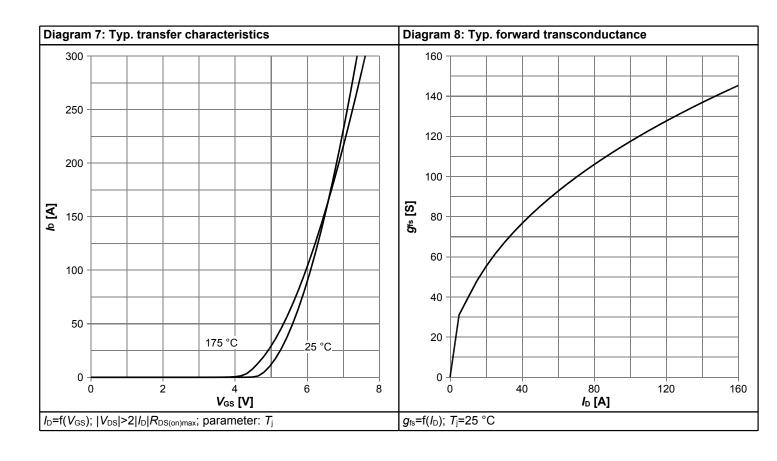
4 Electrical characteristics diagrams



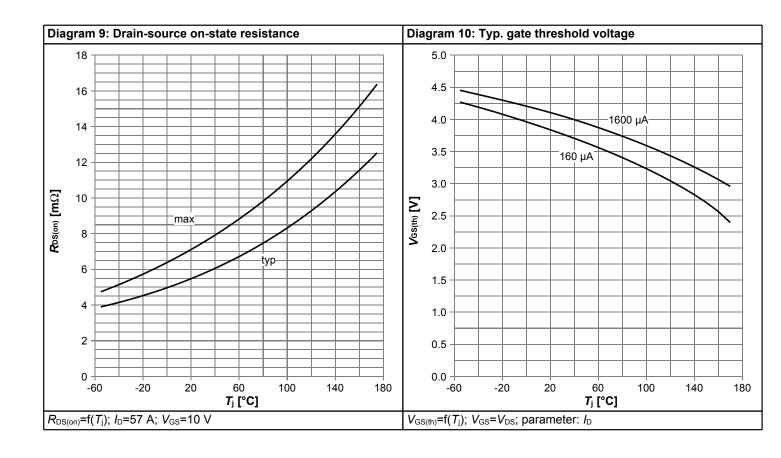


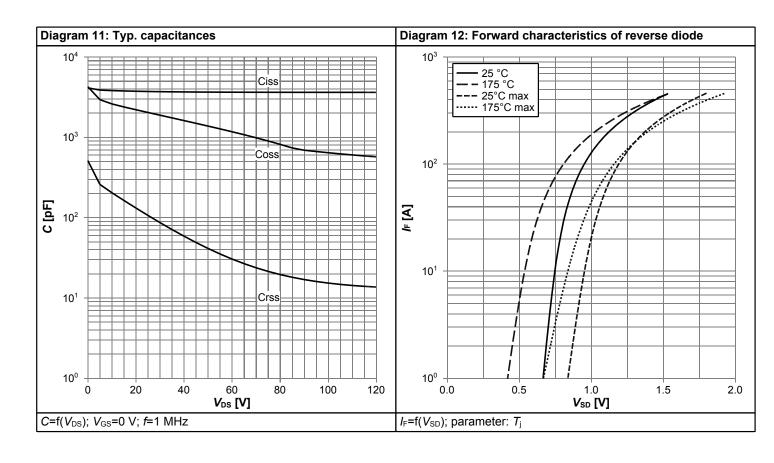




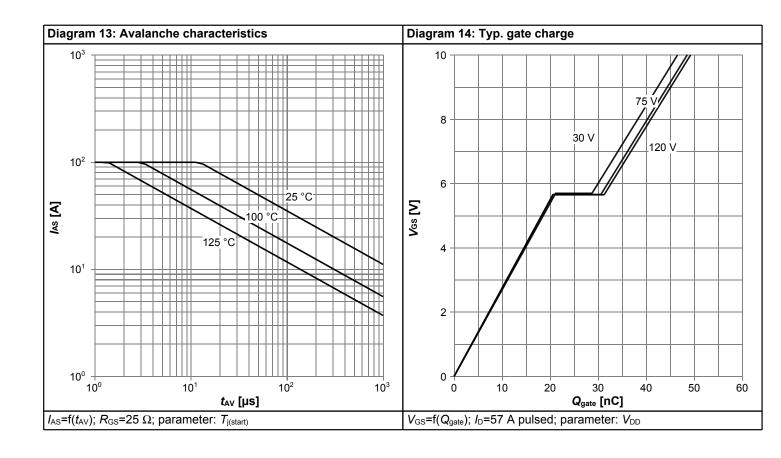


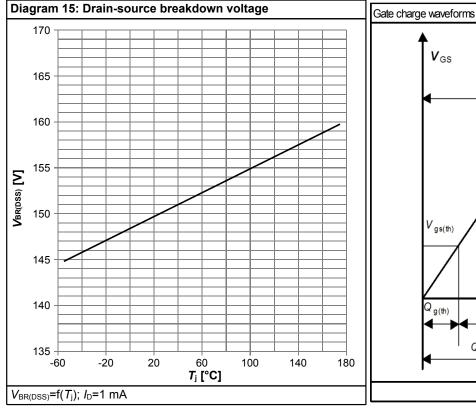


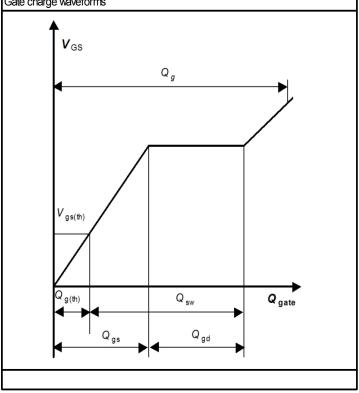






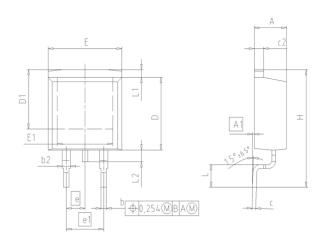


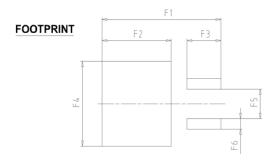






5 Package Outlines





DIM	MILLIN	METERS	INCHES				
DIM	MIN	MAX	MIN	MAX			
Α	4.30	4.57	0.169	0.180			
A1	0.00	0.25	0.000	0.010			
b	0.65	0.85	0.026	0.033			
b2	0.95	1.15	0.037	0.045			
С	0.33	0.65	0.013	0.026			
c2	1.17	1.40	0.046	0.055			
D	8.51	9.45	0.335	0.372			
D1	7.10	7.90	0.280	0.311			
E	9.80	10.31	0.386	0.406			
E1	6.50	8.60	0.256	0.339			
е	2.	54	0.100				
e1	5.	08	0.200				
N		2	2				
Н	14.61	15.88	0.575	0.625			
L	2.29	3.00	0.090	0.118			
L1	0.70	1.60	0.028	0.063			
L2	1.00	1.78	0.039	0.070			
F1	16.05	16.25	0.632	0.640			
F2	9.30	9.50	0.366	0.374			
F3	4.50	4.70	0.177	0.185			
F4	10.70	10.90	0.421	0.429			
F5	3.65	3.85	0.144	0.152			
F6	1.25	1.45	0.049	0.057			

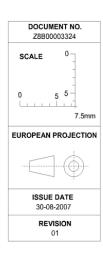


Figure 1 Outline PG-TO 263, dimensions in mm/inches

OptiMOS[™]5 Power-Transistor, 150 V IPB073N15N5



Revision History

IPB073N15N5

Revision: 2016-03-17, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)			
2.0	2016-03-17	Release of final version			

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